

45 V, 100 mA NPN general-purpose transistors Rev. 1 — 5 March 2012 P

Product data sheet

1. **Product profile**

1.1 General description

NPN general-purpose transistors in a leadless ultra small SOT883B Surface-Mounted Device (SMD) plastic package.

Table 1. **Product overview**

Type number	Package			PNP complement
	NXP	JEITA	JEDEC	
BC847AMB	SOT883B	-	-	BC857AMB
BC847BMB	SOT883B	-	-	BC857BMB
BC847CMB	SOT883B	-	-	BC857CMB

1.2 Features and benefits

- Leadless ultra small SMD plastic Power dissipation comparable to SOT23 package
- Low package height of 0.37 mm
- AEC-Q101 qualified

1.3 Applications

- General-purpose switching and amplification
- Mobile applications

1.4 Quick reference data

Quick reference data					
Parameter	Conditions	Min	Тур	Max	Unit
collector-emitter voltage	open base	-	-	45	V
collector current		-	-	100	mA
DC current gain	$V_{CE} = 5 \text{ V}; I_{C} = 2 \text{ mA}$				
BC847AMB		110	-	220	
BC847BMB		200	-	450	
BC847CMB		420	-	800	
	Parametercollector-emitter voltagecollector currentDC current gainBC847AMBBC847BMB	ParameterConditionscollector-emitter voltageopen basecollector currentDC current gainDC current gainV _{CE} = 5 V; I _C = 2 mABC847AMBBC847BMB	ParameterConditionsMincollector-emitter voltageopen base-collector currentDC current gainV _{CE} = 5 V; I _C = 2 mA110BC847AMB200	ParameterConditionsMinTypcollector-emitter voltageopen basecollector currentDC current gainV _{CE} = 5 V; I _C = 2 mA110-BC847AMB110-200-	ParameterConditionsMinTypMaxcollector-emitter voltageopen base45collector current100DC current gainV _{CE} = 5 V; I _C = 2 mA110-220BC847AMB110-220200-450



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2. Pinning information

Table 3.	Pinning	
Pin	Description	Simplified outline Graphic symbol
1	base	
2	emitter	
3	collector	
		Transparent cop view 2
		sym021

3. Ordering information

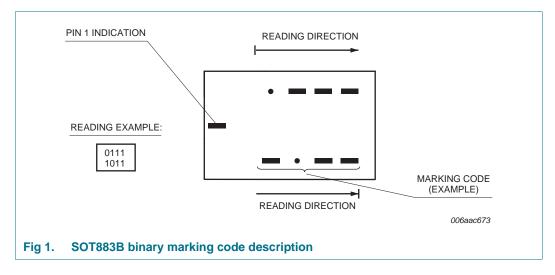
Table 4. Orderin	ng informat	ion	
Type number	Package		
	Name	Description	Version
BC847xMB series	-	leadless ultra small plastic package; 3 solder lands; body 1.0 \times 0.6 \times 0.37 mm	SOT883B

4. Marking

Type number	Marking code ^[1]	
BC847AMB	0100 0001	
BC847BMB	0100 0010	
BC847CMB	0100 0011	

[1] For SOT883B binary marking code description, see Figure 1.

4.1 Binary marking code description



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5. Limiting values

Table 6. In accorda	Limiting values nce with the Absolute Maximu	ım Rating System ((IEC 60	134).		
Symbol	Parameter	Conditions		Min	Max	Unit
V _{CBO}	collector-base voltage	open emitter		-	50	V
V _{CEO}	collector-emitter voltage	open base		-	45	V
V_{EBO}	emitter-base voltage	open collector		-	6	V
I _C	collector current			-	100	mA
I _{CM}	peak collector current	single pulse; $t_p \leq 1 \text{ ms}$		-	200	mA
I _{BM}	peak base current	single pulse; $t_p \leq 1 \text{ ms}$		-	100	mA
P _{tot}	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	[1][2]	-	250	mW
Tj	junction temperature			-	150	°C
T _{amb}	ambient temperature			-55	+150	°C
T _{stg}	storage temperature			-65	+150	°C

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.

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Product data sheet

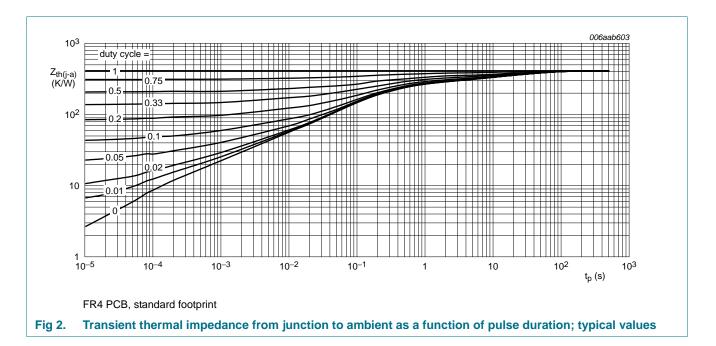
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6. Thermal characteristics

Table 7.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	<u>[1][2]</u> _	-	500	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

[2] Reflow soldering is the only recommended soldering method.



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7. Characteristics

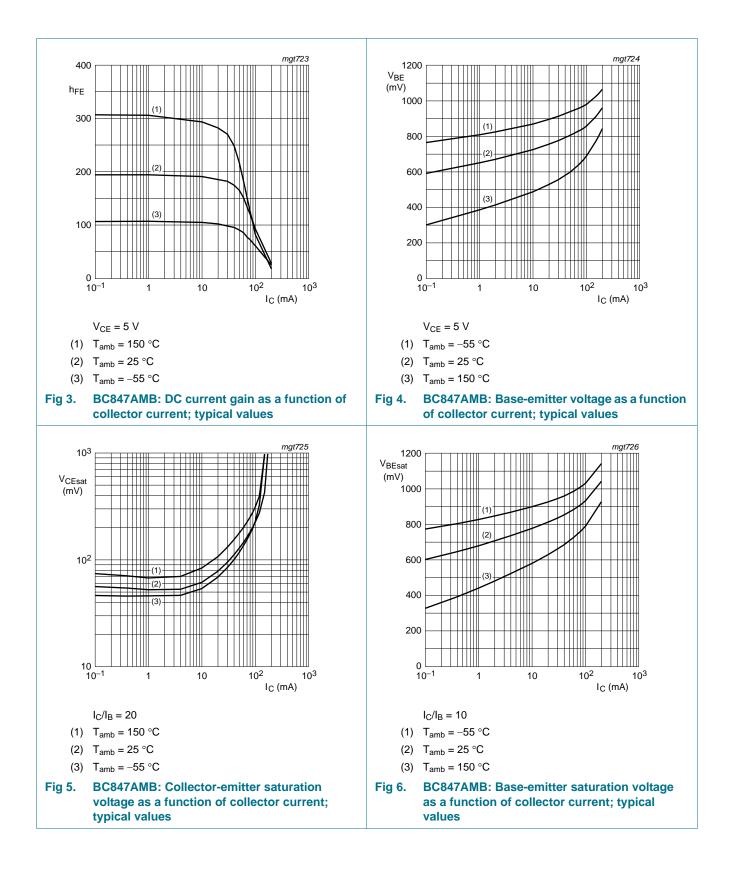
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{CBO}	collector-base	$V_{CB} = 30 \text{ V}; I_E = 0 \text{ A}$		-	-	15	nA
	cut-off current	$\label{eq:VCB} \begin{array}{l} V_{CB} = 30 \; V; \; I_E = 0 \; A; \\ T_j = 150 \; ^\circ C \end{array}$		-	-	5	μA
I _{EBO}	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_{C} = 0 \text{ A}$		-	-	100	nA
h _{FE}	DC current gain	V_{CE} = 5 V; I_{C} = 2 mA					
	BC847AMB			110	-	220	
	BC847BMB			200	-	450	
	BC847CMB			420	-	800	
02000	collector-emitter	$I_C = 10 \text{ mA}; I_B = 0.5 \text{ mA}$		-	90	200	mV
	saturation voltage	$I_C = 100 \text{ mA}; I_B = 5 \text{ mA}$	<u>[1]</u>	-	200	400	mV
V _{BEsat}	base-emitter	$I_{C} = 10 \text{ mA}; I_{B} = 0.5 \text{ mA}$		-	700	-	mV
	saturation voltage	$I_C = 100 \text{ mA}; I_B = 5 \text{ mA}$	[1]	-	900	-	mV
V_{BE}	base-emitter voltage	$I_C = 2 \text{ mA}; V_{CE} = 5 \text{ V}$		580	660	700	mV
		I_C = 10 mA; V_{CE} = 5 V		-	-	770	mV
f _T	transition frequency	$V_{CE} = 5 \text{ V}; I_{C} = 10 \text{ mA};$ f = 100 MHz		100	-	-	MHz
C _c	collector capacitance	$\label{eq:VCB} \begin{array}{l} V_{CB} = 10 \; V; \; I_{E} = i_{e} = 0 \; A; \\ f = 1 \; MHz \end{array}$		-	-	1.5	pF
C _e	emitter capacitance	$V_{EB} = 0.5 \text{ V}; I_{C} = i_{c} = 0 \text{ A};$ f = 1 MHz		-	11	-	pF
NF	noise figure	$I_C = 200 \ \mu$ A; V _{CE} = 5 V; R _S = 2 kΩ; f = 1 kHz; B = 200 Hz		-	2	10	dB

[1] Pulse test: $t_p \le 300 \ \mu s; \ \delta \le 0.02.$

NXP Semiconductors

BC847xMB series

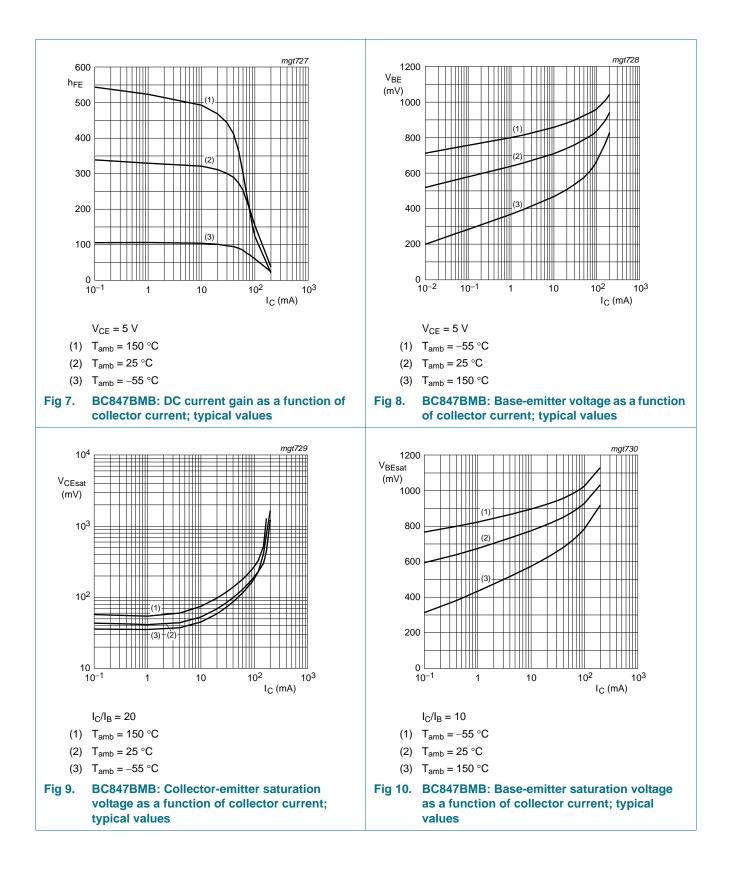
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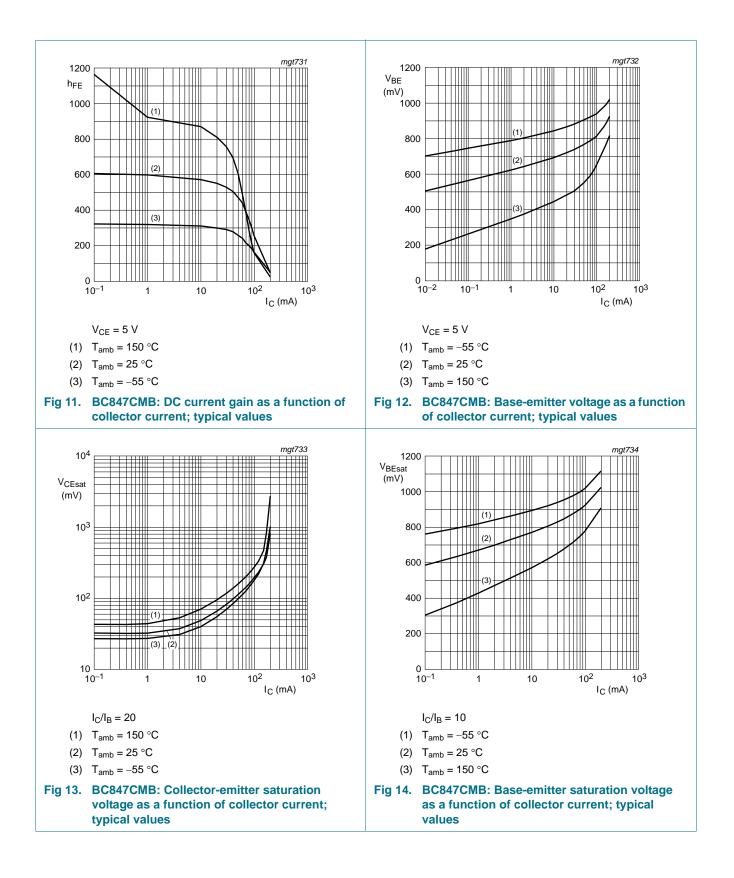
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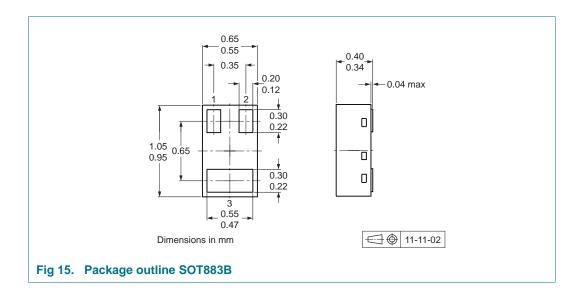
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8. Test information

8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

9. Package outline



10. Packing information

Table 9. Packing methods

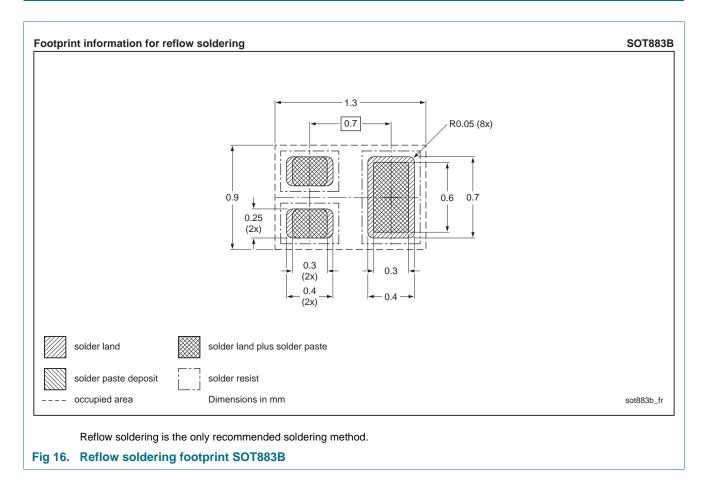
The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing quantity
			10000
BC847xMB series	SOT883B	2 mm pitch, 8 mm tape and reel	-315

[1] For further information and the availability of packing methods, see Section 14.

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11. Soldering



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12. Revision history

Table 10. Revision hist	ble 10. Revision history				
Document ID	Release date	Data sheet status	Change notice	Supersedes	
BC847XMB_SER v.1	20120305	Product data sheet	-	-	

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13. Legal information

13.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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